

TECHNICAL DATA SHEET

REV.

2 DATE 14/10/2019

PRODUCT (A PART)	FONDO POLIURETANICO 149 TIX (FPV102V)		
TECHNICAL DESCRIPTION	TRANSPARENT POLYURETHANE BASE-COAT		
SPECIFICATION AND CHARACTERISTICS	Optimum filling power Optimum transparency Optimum versatility	Optimum vertical hold Optimum sanding	
VERSION / GLOSS			

RECOMMENDED USE

SECTOR OF APPLICATION	General use	General uses – assembled furniture – flat plans – lathed items – profiles – doors						
CATALYST	C301			50%	by weight	50%	by volume	on A part
APPLICATION	quantity g/mq	Nozzle	pressure	THINNER	₹	DK12	9	
Airbrush Spray Airless / Airmix Roller / Brush	100-120 100-120	1.6-1.8 9-11-13	Bar 2.5-3.5		by weight by weight		,	on A part on A part

ASPECT / PHYSICAL STATE	colour	Straw yellow		
VISCOSITY DIN 4 (53211)20°c	Sec	+/- 10	150	
VISCOSITY BROOKFIELD 20°c	мРА*ѕ	+/-1000	1	
SOLID PART (A PART)	%	+/- 2	46	
SOLID PART (B PART)	%	+/- 2	27	
SPECIFIC WEIGHT (A PART)	kg/lt	+/- 0.02	0.96	
SPECIFIC WEIGHT (B PART)	kg/lt	+/- 0.02	0.96	
POT-LIFE / GEL TIME	min	+/- 10	3	
OPACITY / GLOSS	gloss	+/- 2	1	
HARDNESS	pencil	1	1	

GENERAL REMARKS

Drying at 20°C and 65% R.H.		
DUST FREE	15/20 min	
TOUCH DRY	1 h	
STACKABLE	8 h	
SANDING	3 h	
COMPLETELY DRY IN	6 h	
FORCED AIR AT 35°C	3 h	
OVERCOATING BY TOP-COAT	8 h	
INTERVAL BETWEEN COATS (MIN/MAX)	30 min / 4 h	

RECOMMENDED COATING SYSTEM

SUBSTRATE / WOOD	Various
DYE	Various
PRIMER/BASECOAT	FPV102V
SANDING	Sandpaper 280-320 grain
TOP-COAT	OP200V = OPV201 = OPV203 = OP211V = OPV230 = OPV283

ALTERNATIVE CATALYSTS	C302 C320M	Universal uses. Increases drying speed. Universal uses.
ALTERNATIVE	DK605	Retardant thinner for summer or wet periods (5-10% on A part).
THINNERS	DK110	Medium quickness evaporation.

PACKETS	1 – 2 – 5 – 10 – 25 – 50	
SHELF LIFE	12 months at 20°c in original pack.	
SAFETY ADVICES	See information in the safety data sheet.	
GENERAL NOTES	Products for indoor use.	
responsibility of final results of coating system rests entirely with the users who shall make sure that product is in compliance with requirement of substrates used and working conditions		

